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1. Kensuke NAKAMURA
2. Tetsuro SATO

Execution Date(s): 3/28/06

Additional name(s) of conveying party(ies) attached?
attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

NAME: Mitsui Mining & Smelting Co., Ltd.

ADDRESS: 11-1, Osaki 1-chome
Shinagawa-ku, Tokyo 141-8584, Japan

3. Name of Conveyance:

- ☒ Assignment ☐ Merger
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4. Application number(s) or patent number(s):



This document is being filed together with a new application

A. Patent Application No.(s)

B. Patent No.(s)

PCT/JP2004/018355

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Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name:

Address: Rothwell, Figg, Ernst & Manbeck
Suite 800

Street Address: 1425 K St., N.W.

City: Washington,

State: D.C. Zip: 20005

Telephone No.: 202/783-6040

Facsimile No.: 202/783-6031

Email Address:

Attorney Docket No.: 3209-115

6. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41): . . . \$ 40

- ☐ Enclosed
☒ Authorized to be charged to deposit account
☐ None required (government interest not affecting title)

8. Deposit account number: 02-2135

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U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by:

Mitsui Mining & Smelting Co., Ltd.
11-1, Osaki 1-chome,
Shinagawa-ku, Tokyo 141-8584, Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled:

MULTI-LAYERD PRINTED WIRING BOARD AND MANUFACTURING METHOD THEREOF

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

filed on December 9, 2004, PCT/JP2004/018355

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as ASSIGNEE may deem necessary or expedient.

ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventors have affixed their signatures.

Kensuke NAKAMURA


(SIGNATURE)

03 / 28 / 2006
(DATE)

Tetsuro SATO


(SIGNATURE)

03 / 28 / 2006
(DATE)

NO LEGALIZATION REQUIRED